

REVISIONS																			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED																
A	Technical changes in 1.4. Editorial changes throughout.	90 SEPT 24	<i>W. Heckman</i>																

REV	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
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REV STATUS OF SHEETS	REV SHEET	A	A	A	1	2	3	4	5	6	7	8	9	10	11	A	12	13	14	15	16	17	18	19	20

PMIC N/A STANDARDIZED MILITARY DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A	PREPARED BY <i>Larry T. Hayden</i> CHECKED BY <i>Robert M. Helber</i> APPROVED BY <i>William K. Heckman</i> DRAWING APPROVAL DATE 19 OCTOBER 1989 REVISION LEVEL A	DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 MICROCIRCUIT, DIGITAL, BIPOLAR, ADVANCED SCHOTTKY TTL, 8-BIT MAGNITUDE COMPARATOR, MONOLITHIC SILICON <table style="width: 100%;"> <tr> <td style="width: 15%;">SIZE A</td> <td style="width: 25%;">CAGE CODE 67268</td> <td style="width: 60%;">5962-89757</td> </tr> <tr> <td colspan="2">SHEET</td> <td style="text-align: right;">1</td> </tr> </table>	SIZE A	CAGE CODE 67268	5962-89757	SHEET		1
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• U.S. GOVERNMENT PRINTING OFFICE: 1987 — 748-129/60911

5962-E1762

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:

5962-89757	01	K	X
┆	┆	┆	┆
┆	┆	┆	┆
┆	┆	┆	┆
┆	┆	┆	┆
Drawing number	Device type (1.2.1)	Case outline (1.2.2)	Lead finish per MIL-M-38510

1.2.1 Device type. The device type shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54AS885	8-bit magnitude comparator

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
K	F-6 (24-lead, .640" x .420" x .090"), flat package
L	D-9 (24-lead, 1.280" x .310" x .200"), dual-in-line package
3	C-4 (28-terminal, .460" x .460" x .100"), square chip carrier package

1.3 Absolute maximum ratings.

Supply voltage range	- - - - -	-0.5 V dc to +7.0 V dc
Input voltage range	- - - - -	-1.2 V dc at .18 mA to +7.0 V dc
Storage temperature range	- - - - -	-65°C to +150°C
Lead temperature (soldering, 10 seconds)	- - - - -	+300°C
Thermal resistance, junction-to-case (θ_{JC})	- - - - -	See MIL-M-38510, appendix C
Maximum power dissipation (P_D) 1/	- - - - -	1.155 W
Junction temperature (T_J)	- - - - -	+175°C

1.4 Recommended operating conditions.

Supply voltage range (V_{CC})	- - - - -	+4.5 V dc minimum to +5.5 V dc maximum
Minimum high level input voltage (V_{IH})	- - - - -	+2.0 V dc
Maximum low level input voltage (V_{IL})	- - - - -	+0.8 V dc
Case operating temperature range (T_C)	- - - - -	-55°C to +125°C
Setup time to PLE switching from high to low (t_s)	- - - - -	2.0 ns minimum
Hold time after PLE switches from high to low (t_h)	- - - - -	4.5 ns minimum

1/ Maximum power dissipation is defined as $V_{CC} \times I_{CC}$, and must withstand the added P_D due to short circuit test; e.g., I_0 .

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103 - List of Standard Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth table. The truth table shall be as specified on figure 2.

3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.4 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figure 3.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see 6.6 herein).

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DAYTON, OHIO 45444

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C < T _C < +125°C unless otherwise specified <u>1/</u>	Group A subgroups	Limits		Unit
				Min	Max	
High level output voltage	V _{OH}	V _{CC} = 4.5 V, V _{IL} = 0.8 V, V _{IH} = 2.0 V, I _{OH} = -2 mA <u>2/</u>	1, 2, 3	2.5		V
Low level output voltage	V _{OL}	V _{CC} = 4.5 V, V _{IL} = 0.8 V, V _{IH} = 2.0 V, I _{OL} = 20 mA <u>2/</u>	1, 2, 3		0.5	V
Input clamp voltage	V _{IC}	V _{CC} = 4.5 V, I _{IN} = -18 mA	1, 2, 3		-1.2	V
High level input current	I _{IH1}	V _{CC} = 5.5 V	1, 2, 3		100	μA
	I _{IH2}	V _{IN} = 7.0 V				
		V _{IN} = 2.7 V			40	
Low level input current	I _{IL}	V _{CC} = 5.5 V, V _{IN} = 0.4 V	1, 2, 3			mA
					-4	
					-2	
					-2	
Output current	I _O	V _{CC} = 5.5 V, V _{OUT} = 2.25 V <u>3/</u>	1, 2, 3	-20	-112	mA
Supply current	I _{CC}	V _{CC} = 5.5 V <u>4/</u>	1, 2, 3		210	mA
Functional tests		See 4.3.1c <u>5/</u>	7, 8			

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T _C < +125°C unless otherwise specified 1/	Group A subgroups	Limits		Unit
				Min	Max	
Propagation delay time, L/ \bar{A} to P<Qout, P>Qout	tPLH1	V _{CC} = 4.5 V to 5.5 V C _L = 50 pF R _L = 500Ω See figure 3 6/	9, 10, 11	2	14	ns
	tPHL1			2	14	
Propagation delay time, P<Qin, P>Qin to P<Qout, P>Qout	tPLH2		9, 10, 11	2	10	ns
	tPHL2			2	10	
Propagation delay time, Any Pn, Qn data input to P<Qout, P>Qout	tPLH3		9, 10, 11	2	21	ns
	tPHL3			2	17	

- 1/ Unused inputs that do not directly control the pin under test must be put at ≥ 2.5 V or ≤ 0.4 V. No unused inputs shall exceed 5.5 V or go less than 0.0 V. No inputs shall be floated.
- 2/ All outputs must be tested. In the case where only one input at V_{IL} maximum or V_{IH} minimum produces the proper state, the test must be performed with each input being selected as the V_{IL} maximum or V_{IH} minimum input.
- 3/ The output conditions have been chosen to produce a current that closely approximates one-half of the true short circuit output current, I_{OS}. Not more than one output will be tested at one time and duration of the test condition shall not exceed 1 second.
- 4/ I_{CC} is measured with all inputs high except L/ \bar{A} , which is low.
- 5/ Functional tests shall be conducted at input test conditions of GND \leq V_{IL} \leq V_{OL} and V_{OH} \leq V_{IH} \leq V_{CC}.
- 6/ Propagation delay limits are based on single output switching. Unused inputs = 3.5 V or ≤ 0.3 V.

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Device type	01	
Case outlines	K and L	3
Terminal number	Terminal symbol	
1	L/ \bar{A}	NC
2	P<Qin	L/ \bar{A}
3	P>Qin	P<Qin
4	Q7	P>Qin
5	Q6	Q7
6	Q5	Q6
7	Q4	Q5
8	Q3	NC
9	Q2	Q4
10	Q1	Q3
11	Q0	Q2
12	GND	Q1
13	P>Qout	Q0
14	P<Qout	GND
15	P0	NC
16	P1	P>Qout
17	P2	P<Qout
18	P3	P0
19	P4	P1
20	P5	P2
21	P6	P3
22	P7	NC
23	PLE	P4
24	VCC	P5
25	---	P6
26	---	P7
27	---	PLE
28	---	VCC

NC = No connection

FIGURE 1. Terminal connections.

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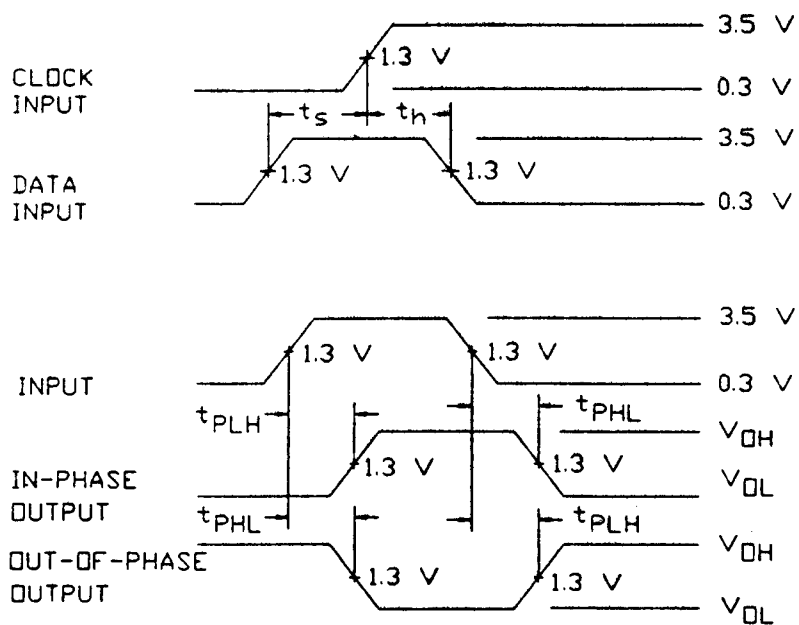
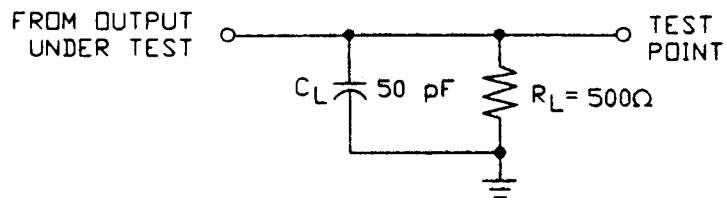
Comparison mode	Inputs				Outputs	
	L/\bar{A}	P0-P7, Q0-Q7	$P > Q_{in}$	$P < Q_{in}$	$P > Q_{out}$	$P < Q_{out}$
Logical	H	$P > Q$	X	X	H	L
Logical	H	$P < Q$	X	X	L	H
Logical (see note)	H	$P = Q$	H/L	H/L	H/L	H/L
Arithmetic	L	$P \text{ AG } Q$	X	X	H	L
Arithmetic	L	$Q \text{ AG } P$	X	X	L	H
Arithmetic (see note)	L	$P = Q$	H/L	H/L	H/L	H/L

H = High voltage level
 L = Low voltage level
 X = Irrelevant
 AG = Arithmetically greater than
 H/L = High or low voltage level

NOTE: In these cases, the $P > Q$ output will follow the $P > Q$ input, and the $P < Q$ output will follow the $P < Q$ input.

FIGURE 2. Truth table.

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NOTES:

1. All input pulses have the following characteristics:
PRR < 10 MHz, duty cycle = 50%, $t_r = t_f = 3 \text{ ns} \pm 1 \text{ ns}$.
2. The outputs are measured one at a time with one input transition per measurement.
3. C_L includes probe and jig capacitance.

FIGURE 3. Test circuit and switching waveforms.

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3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DESC-ECC shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.9 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroups 7 and 8 shall verify the truth table as specified on figure 2.

4.3.2 Groups C and D inspections.

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test conditions, method 1005 of MIL-STD-883:

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

(3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	*1, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

*PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD form 1693, Engineering Change Proposal (short form).

6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECC, telephone (513) 296-6022.

6.5 Comments. Comments on this drawing should be directed to DESC-ECC, Dayton, Ohio 45444, or telephone (513) 296-8525.

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6.6 Approved source of supply. An approved source of supply is listed in MIL-BUL-103. Additional sources will be added to MIL-BUL-103 as they become available. The vendor listed in MIL-BUL-103 has agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECC. The approved source of supply listed below is for information purposes only and is current only to the date of the last action of this document.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1/</u>
5962-8975701KX	01295	SNJ54AS885W
5962-8975701LX	01295	SNJ54AS885JT
5962-89757013X	01295	SNJ54AS885FK

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

01295

Vendor name
and address

Texas Instruments, Incorporated
13500 North Central Expressway
P.O. Box 655303
Dallas, TX 75265
Point of contact: I-20 at FM1788
Midland, TX 79711-0448

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